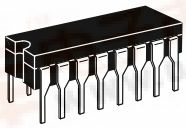
全新MC14583B供应商 捷多邦，专业PCB打样工厂，24小时加急出货

MC14583B

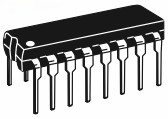
Dual Schmitt Trigger

The MC14583B is a dual Schmitt trigger constructed with complementary P–channel and N–channel MOS devices on a monolithic silicon substrate. Each Schmitt trigger is functionally independent except for a common 3–state input and an internally–connected Exclusive OR output for use in line receiver applications. Trigger levels are adjustable through the positive, negative, and common terminals with the use of external resistors. Applications include the speed–up of a slow waveform edge in interface receivers, level detectors, etc.

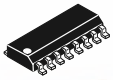
- Diode Protection on All Inputs
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Single Supply Operation
- Capable of Driving Two Low–power TTL Loads or One Low–power Schottky TTL Load Over the Rated Temperature Range
- Resistor Adjustable Trigger Levels



L SUFFIX
CERAMIC
CASE 620



P SUFFIX
PLASTIC
CASE 648



D SUFFIX
SOIC
CASE 751B

ORDERING INFORMATION

MC14XXXBCP	Plastic
MC14XXXBCL	Ceramic
MC14XXXBD	SOIC

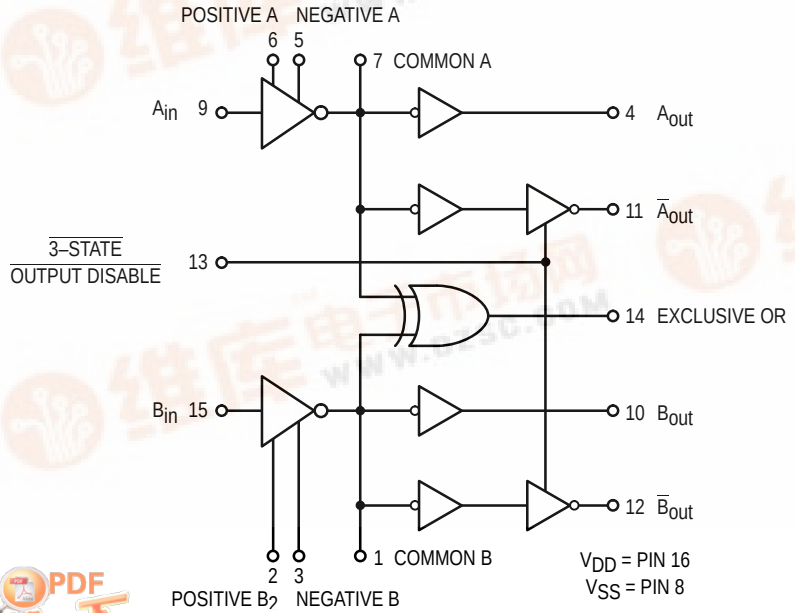
T_A = – 55° to 125°C for all packages.

MAXIMUM RATINGS* (Voltages Referenced to V_{SS})

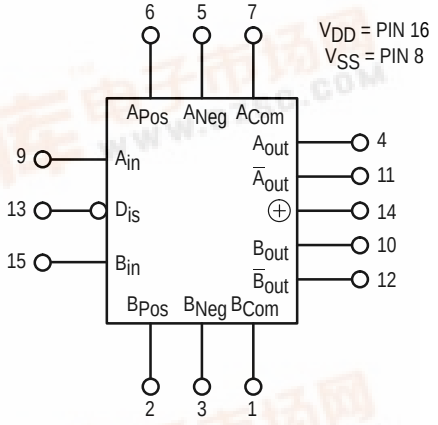
Symbol	Parameter	Value	Unit
V_{DD}	DC Supply Voltage	– 0.5 to + 18.0	V
V_{in}, V_{out}	Input or Output Voltage (DC or Transient)	– 0.5 to V_{DD} + 0.5	V
I_{in}, I_{out}	Input or Output Current (DC or Transient), per Pin	± 10	mA
P_D	Power Dissipation, per Package†	500	mW
T_{stg}	Storage Temperature	– 65 to + 150	°C
T_L	Lead Temperature (8–Second Soldering)	260	°C

* Maximum Ratings are those values beyond which damage to the device may occur.
†Temperature Derating:
Plastic “P and D/DW” Packages: – 7.0 mW/°C From 65°C To 125°C
Ceramic “L” Packages: – 12 mW/°C From 100°C To 125°C

LOGIC DIAGRAM



BLOCK DIAGRAM



TRUTH TABLE

Inputs			Outputs				
A	B	$\overline{Dis}$	A_{out}	$\overline{A}_{out}$	B_{out}	$\overline{B}_{out}$	⊕
0	0	0	0	Z	0	Z	0
0	0	1	0	1	0	1	0
0	1	0	0	Z	1	Z	1
0	1	1	0	1	1	0	1
1	0	0	1	Z	0	Z	1
1	0	1	1	0	0	1	1
1	1	0	1	Z	1	Z	0
1	1	1	1	0	1	0	0

Z = High impedance at output

找PDF 维库一下 pdf.ozsc.com

© Motorola, Inc. 1995

ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

Characteristic	Symbol	V_{DD} Vdc	– 55°C Min	– 55°C Max	25°C Min	25°C Typ #	25°C Max	125°C Min	125°C Max	Unit
Output Voltage "0" Level V_{in} = V_{DD} or 0	V_{OL}	5.0	—	0.05	—	0	0.05	—	0.05	Vdc
		10	—	0.05	—	0	0.05	—	0.05	
		15	—	0.05	—	0	0.05	—	0.05	
"1" Level V_{in} = 0 or V_{DD}	V_{OH}	5.0	4.95	—	4.95	5.0	—	4.95	—	Vdc
		10	9.95	—	9.95	10	—	9.95	—	
		15	14.95	—	14.95	15	—	14.95	—	
Input Voltage "0" Level	V_{IL}									Vdc
(V_O = 4.5 or 0.5 Vdc)		5.0	—	1.5	—	2.25	1.5	—	1.5	
(V_O = 9.0 or 1.0 Vdc)		10	—	3.0	—	4.50	3.0	—	3.0	
(V_O = 13.5 or 1.5 Vdc)		15	—	4.0	—	6.75	4.0	—	4.0	
"1" Level	V_{IH}									Vdc
(V_O = 0.5 or 4.5 Vdc)		5.0	3.5	—	3.5	2.75	—	3.5	—	
(V_O = 1.0 or 9.0 Vdc)		10	7.0	—	7.0	5.50	—	7.0	—	
(V_O = 1.5 or 13.5 Vdc)		15	11	—	11	8.25	—	11	—	
Output Drive Current	I_{OH}									mAdc
(V_{OH} = 2.5 Vdc) Source		5.0	– 1.2	—	– 1.0	– 1.7	—	– 0.7	—	
(V_{OH} = 4.6 Vdc)		5.0	– 0.25	—	– 0.2	– 0.36	—	– 0.14	—	
(V_{OH} = 9.5 Vdc)		10	– 1.62	—	– 0.5	– 0.9	—	– 0.35	—	
(V_{OH} = 13.5 Vdc)		15	– 1.8	—	– 1.5	– 3.5	—	– 1.1	—	
(V_{OL} = 0.4 Vdc) Sink	I_{OL}	5.0	0.64	—	0.51	0.88	—	0.36	—	mAdc
(V_{OL} = 0.5 Vdc)		10	1.6	—	1.3	2.25	—	0.9	—	
(V_{OL} = 1.5 Vdc)		15	4.2	—	3.4	8.8	—	2.4	—	
Input Current	I_{in}	15	—	±0.1	—	±0.00001	±0.1	—	±1.0	µAdc
Input Capacitance (V_{in} = 0)	C_{in}	—	—	—	—	5.0	7.5	—	—	pF
Quiescent Current (Per Package)	I_{DD}	5.0	—	0.25	—	0.0005	0.25	—	7.5	µAdc
		10	—	0.5	—	0.0010	0.5	—	15	
		15	—	1.0	—	0.0015	1.0	—	30	
Total Supply Current**† (Dynamic plus Quiescent, Per Package) (C_L = 50 pF on all outputs, all buffers switching)	I_T	5.0	I_T = (1.33 µA/kHz) f + I_{DD}							µAdc
		10	I_T = (2.65 µA/kHz) f + I_{DD}							
		15	I_T = (3.98 µA/kHz) f + I_{DD}							
Three–State Leakage Current	I_{TL}	15	—	±0.1	—	±0.0001	±0.1	—	±3.0	µAdc

#Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

**The formulas given are for the typical characteristics only at 25°C.

†To calculate total supply current at loads other than 50 pF:

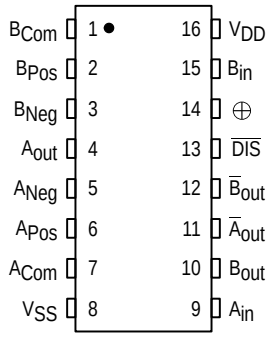
$$I_T(C_L) = I_T(50\ pF) + (C_L - 50)\ Vfk$$

where: I_T is in µA (per package), C_L in pF, V = (V_{DD} – V_{SS}) in volts, f in kHz is input frequency, and k = 0.005.

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \le (V_{in}$ or $V_{out}) \le V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.

PIN ASSIGNMENT

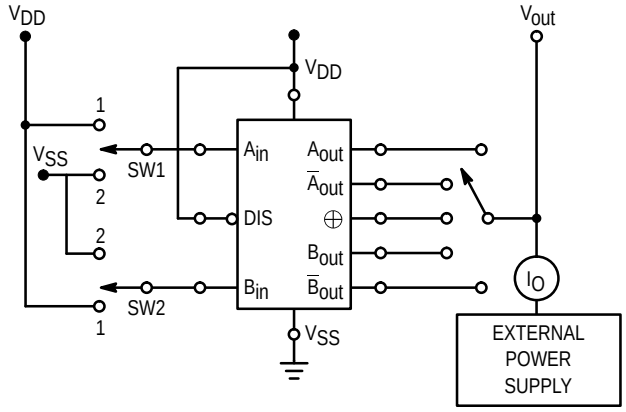


SWITCHING CHARACTERISTICS* (C_L = 50 pF, T_A = 25°C)

Characteristic	Symbol	V_{DD}	Min	Typ #	Max	Unit
Output Rise Time	t_{TLH}					ns
t_{TLH} = (3.0 ns/pF) C_L + 30 ns		5.0	—	180	360	
t_{TLH} = (1.5 ns/pF) C_L + 15 ns		10	—	90	180	
t_{TLH} = (1.1 ns/pF) C_L + 10 ns		15	—	65	130	
Output Fall Time	t_{THL}					ns
t_{THL} = (1.5 ns/pF) C_L + 25 ns		5.0	—	100	200	
t_{THL} = (0.75 ns/pF) C_L + 12.5 ns		10	—	50	100	
t_{THL} = (0.55 ns/pF) C_L + 9.5 ns		15	—	40	80	
Propagation Delay Time	t_{PLH},					ns
A_{in}, B_{in} to A_{out}, B_{out}	t_{PHL}					
t_{PLH}, t_{PHL} = (1.7 ns/pF) C_L + 565 ns		5.0	—	650	1300	
t_{PLH}, t_{PHL} = (0.66 ns/pF) C_L + 197 ns		10	—	230	460	
t_{PLH}, t_{PHL} = (0.5 ns/pF) C_L + 125 ns		15	—	150	300	
A_{in}, B_{in} to A_{out}, B_{out}	t_{PLH},					ns
t_{PLH}, t_{PHL} = (1.7 ns/pF) C_L + 1015 ns	t_{PHL}	5.0	—	1100	2200	
t_{PLH}, t_{PHL} = (0.66 ns/pF) C_L + 347 ns		10	—	380	760	
t_{PLH}, t_{PHL} = (0.5 ns/pF) C_L + 235 ns		15	—	260	520	
A_{in}, B_{in} to Exclusive OR	t_{PLH},					ns
t_{PLH}, t_{PHL} = (1.7 ns/pF) C_L + 665 ns	t_{PHL}	5.0	—	750	1500	
t_{PLH}, t_{PHL} = (0.66 ns/pF) C_L + 257 ns		10	—	280	560	
t_{PLH}, t_{PHL} = (0.5 ns/pF) C_L + 145 ns		15	—	170	340	
3–State Enable, Disable Delay Time (see figure 5)	t_{on},					ns
t_{on}, t_{off} = (1.7 ns/pF) C_L + 140 ns	t_{off}	5.0	—	225	450	
t_{on}, t_{off} = (0.66 ns/pF) C_L + 57 ns		10	—	90	180	
t_{on}, t_{off} = (0.5 ns/pF) C_L + 30 ns		15	—	55	110	
Positive Threshold Voltage	V_{T+}	5.0	—	3.30	—	Vdc
(R1, R2 = 5.0 kΩ)		10	—	5.70	—	
		15	—	8.20	—	
Negative Threshold Voltage	V_{T-}	5.0	—	1.70	—	Vdc
(R1, R2 = 5.0 kΩ)		10	—	4.30	—	
		15	—	6.80	—	
Hysteresis Voltage	V_H	5.0	0.85	1.70	3.40	Vdc
(R1, R2 = 5.0 kΩ)		10	0.70	1.40	2.80	
		15	0.70	1.40	2.80	
Threshold Voltage Variation, A to B	ΔV_T	5.0	—	0.1	—	Vdc
(R1, R2 = 5.0 kΩ)		10	—	0.15	—	
		15	—	0.20	—	

* The formulas given are for the typical characteristics only at 25°C.

#Data labelled “Typ” is not to be used for design purposes but is intended as an indication of the IC’s potential performance.



Output Under Test	Output Source Characteristics		Output Sink Characteristics	
	Test Value $V_{GS} = -V_{DD}$, $V_{DS} = V_{out} - V_{DD}$		Test Value $V_{GS} = V_{DD}$, $V_{DS} = V_{out}$	
	Switch Position		Switch Position	
	SW1	SW2	SW1	SW2
A_{out}, B_{out}	1	1	2	2
$\overline{A}_{out}$, $\overline{B}_{out}$	2	2	1	1
Exclusive OR	1	2	1	1

Figure 1. Typical Output Source and Sink Characteristics Test Circuit

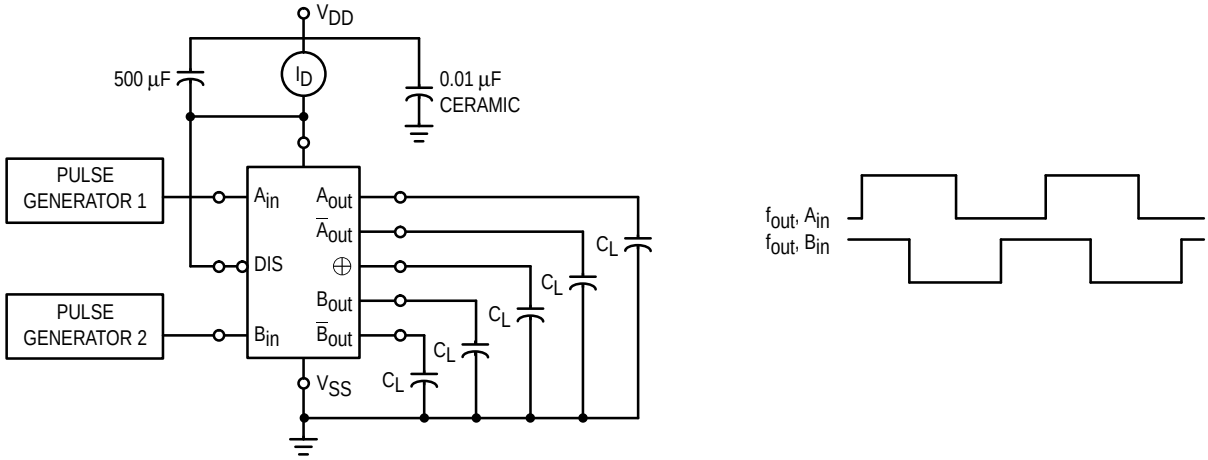
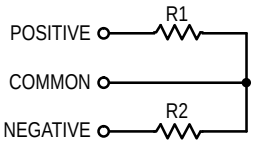
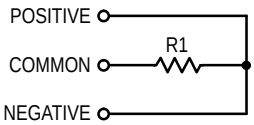


Figure 2. Power Dissipation Test Circuit and Waveforms

A — Feedback scheme for independent threshold adjustment:



B — Feedback scheme for hysteresis adjustment:



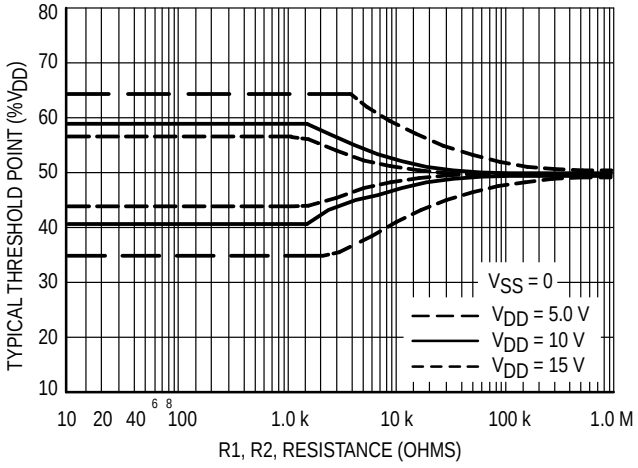
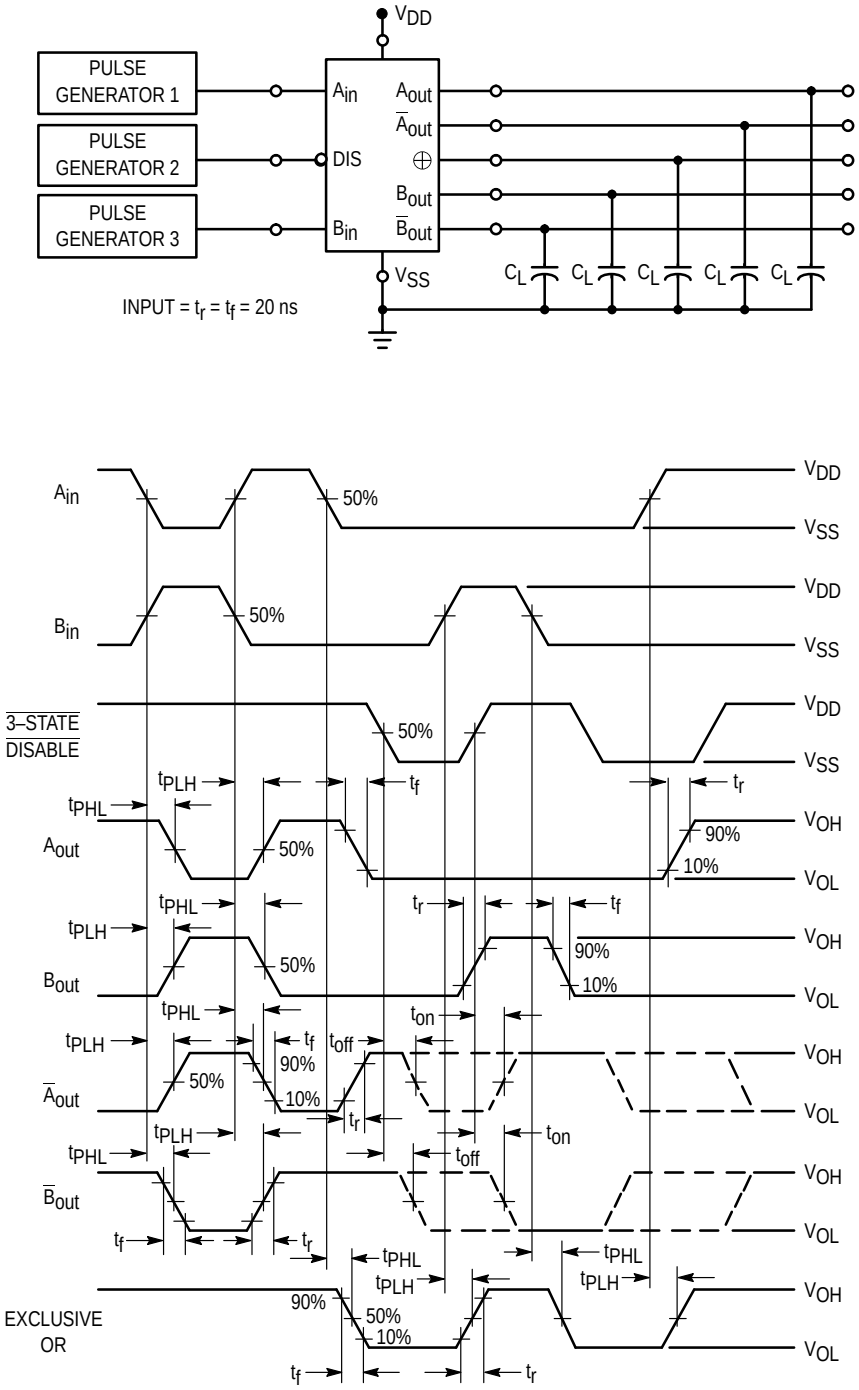
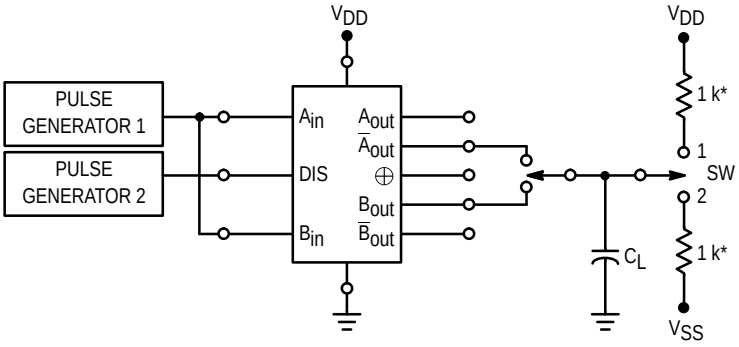


Figure 3. Typical Threshold Points



NOTE: Dashed lines indicate high output resistance

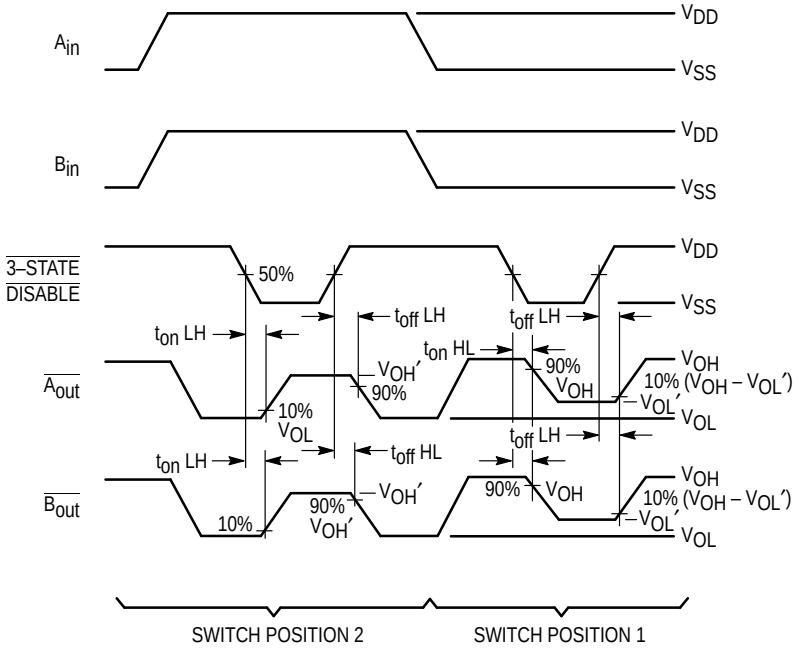
Figure 4. Switching Time Test Circuit and Waveforms



Test	Switch Position
t_{on} HL	1
t_{on} LH	2
t_{off} HL	2
t_{off} LH	1

* Metal film, ± 1%, 1/4 W or greater

C_L = 15 pF, which includes test circuit capacitance.

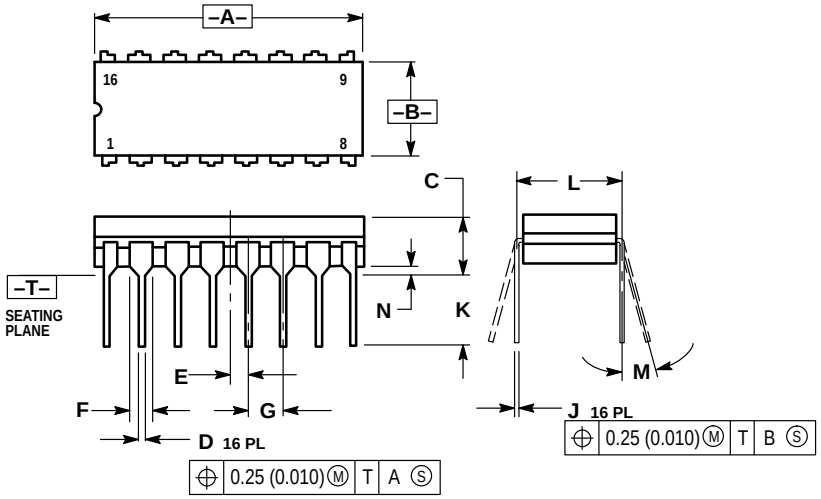


V_{OL}' and V_{OH}' refer to the levels present as a result of the 1 k ohm load resistors.

Figure 5. 3–State Switching Time Test Circuit and Waveforms

OUTLINE DIMENSIONS

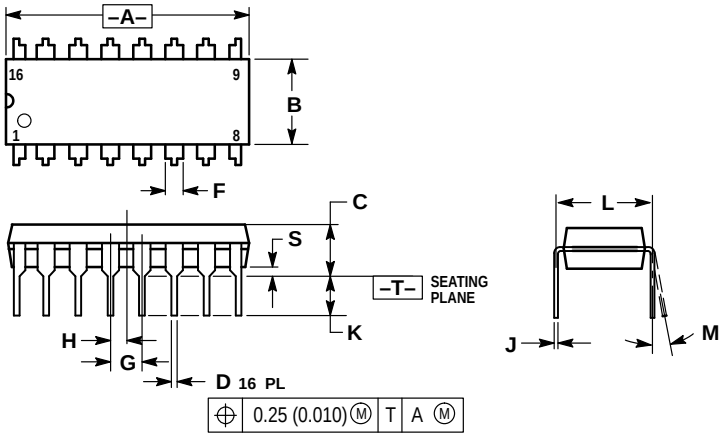
L SUFFIX
CERAMIC DIP PACKAGE
CASE 620–10
ISSUE V



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	—	0.200	—	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0 °	15 °	0 °	15 °
N	0.020	0.040	0.51	1.01

P SUFFIX
PLASTIC DIP PACKAGE
CASE 648–08
ISSUE R

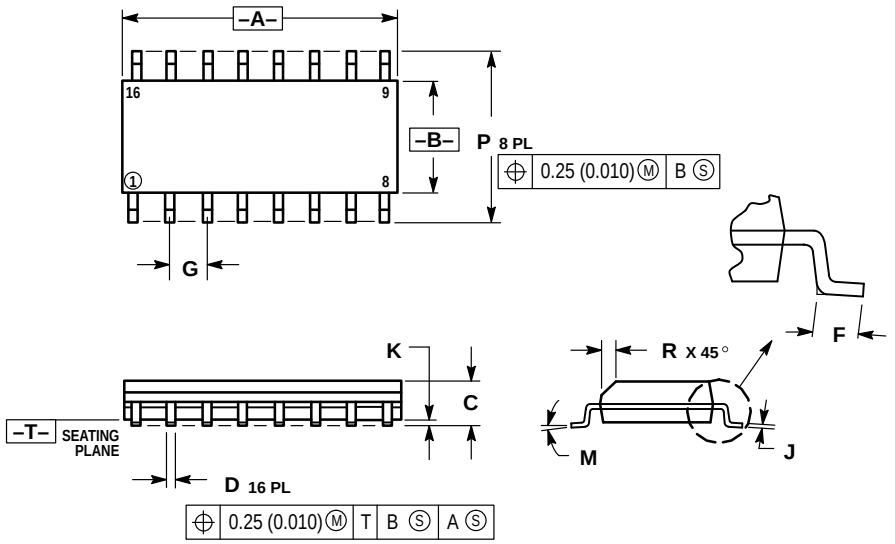


NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0 °	10 °	0 °	10 °
S	0.020	0.040	0.51	1.01

OUTLINE DIMENSIONS

D SUFFIX
PLASTIC SOIC PACKAGE
CASE 751B–05
ISSUE J



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

Motorola reserves the right to make changes without further notice to any products herein. Motorola makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Motorola assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. “Typical” parameters which may be provided in Motorola data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including “Typicals” must be validated for each customer application by customer’s technical experts. Motorola does not convey any license under its patent rights nor the rights of others. Motorola products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Motorola was negligent regarding the design or manufacture of the part. Motorola and M are registered trademarks of Motorola, Inc. Motorola, Inc. is an Equal Opportunity/Affirmative Action Employer.

How to reach us:
USA/EUROPE/Locations Not Listed: Motorola Literature Distribution; P.O. Box 20912; Phoenix, Arizona 85036. 1–800–441–2447 or 602–303–5454

MFAX: RMFAX0@email.sps.mot.com – TOUCHTONE 602–244–6609
INTERNET: http://Design–NET.com

JAPAN: Nippon Motorola Ltd.; Tatsumi–SPD–JLDC, 6F Seibu–Butsuryu–Center, 3–14–2 Tatsumi Koto–Ku, Tokyo 135, Japan. 03–81–3521–8315

ASIA/PACIFIC: Motorola Semiconductors H.K. Ltd.; 8B Tai Ping Industrial Park, 51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852–26629298